## UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO.

: 6,872,591 B1

: March 29, 2005

DATED

INVENTOR(S) : Chia-Chung Wang et al.

Page 1 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

#### Column 18,

Lines 15 and 17, change "1D" to -- 11D --.

#### Column 21,

Lines 25 and 27, change "131" to -- 13I --.

#### Column 27,

Lines 21 and 23, change "291" to -- 29I --.

## Column 32,

Lines 14 and 16, change "451" to -- 45I --.

#### Column 33,

Line 65, change "586" to -- 58B --.

## Column 56,

Line 13, change "Interconnect" to -- interconnect --.

## Column 60,

Line 6, change "open ing" to -- opening --.

#### Column 61,

Line 63, change "Is" to -- is --.

#### Column 66,

Line 10, change "(I)" to -- (i) --.

## Column 69,

Line 40, change "Into" to -- into --.

#### Column 70,

Line 63, change "muting" to -- routing --.

## Column 82,

Line 2, change "meta," to -- metal --.

## Column 83,

Line 32, change "Into" to -- into --.

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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

## Column 88,

Line 9, change "Into" to -- into --.

## Column 89,

Lines 24-26, "disposing an insulative base...and the substrate; then" is a subparagraph.

## Column 104,

Line 2, change "muting" to -- routing --.

Signed and Sealed this

Thirty-first Day of May, 2005

JON W. DUDAS
Director of the United States Patent and Trademark Office